

NOT RECOMMENDED FOR NEW DESIGN USE SBR2M60S1F



SDM2M60S1F

2.0A SCHOTTKY BARRIER RECTIFIER

Product Summary (@TA = +25°C)

V _{RRM} (V)	I _O (A)	V _{F(MAX)} (V)	I _{R(MAX)} (μA)		
60	2	0.76	0.3		

Description and Applications

The SDM2M60S1F is a single rectifier packaged in SOD123F (Standard), offering very low forward voltage drop (V_F) and excellent low reverse leakage stability at high temperatures.

- DC-DC Converter
- AC-DC Rectifier
- Reverse Polarity Protection
- SMPS

Features and Benefits

- Superior Reverse Avalanche Capability
- Patented Interlocking Clip Design for High Surge Current Capacity
- Soft, Fast Switching Capability
- +175°C Operation Junction Temperature
- Lead-Free Finish; RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)

Mechanical Data

- Case: SOD123F (Standard)
- Case Material: Molded Plastic, "Green" Molding Compound.
 UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Matte Tin Finish Annealed over Copper Leadframe.
 Solderable per MIL-STD-202, Method 208 3
- Polarity: Cathode Band
- Weight: 0.015 grams (Approximate)

SOD123F (Standard)



Top View

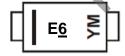
Ordering Information (Note 4)

	_	_		
Part Number			Case	Packaging
SDM2M60S1F-7			SOD123F (Standard)	3000/Tape & Reel

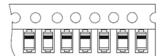
Notes:

- 1. EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant. All applicable RoHS exemptions applied.
- 2. See http://www.diodes.com/quality/lead_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/.

Marking Information



E6 = Product Type Marking Code YM = Date Code Marking Y = Year (ex: E = 2017) M = Month (ex: 2 = February)



Date Code Key

Bate Code Hoy								
Year	2015	2016	2017	2018	2019	2020	2021	2022
Code	С	D	E	F	G	Н	I	J

Month	Jan	Feb	Mar	Apr	May	Jun	Jul	Aug	Sep	Oct	Nov	Dec
Code	1	2	3	4	5	6	7	8	9	0	N	D



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Maximum Ratings ($@T_A = +25^{\circ}C$, unless otherwise specified.)

Characteristic	Symbol	Value	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V _{RRM}	60	V
Average Rectified Output Current	Io	2	Α
Non-Repetitive Peak Forward Surge Current 8.3mS	I _{FSM}	60	A

Thermal Characteristics

Characteristic	Symbol	Value	Unit
Maximum Thermal Resistance Junction to Ambient (Note 5)	$R_{\theta JA}$	70	°C/W
Maximum Thermal Resistance Junction to Case (Note 5)	$R_{\theta JC}$	20	.cw
Operating and Storage Temperature Range	$T_{J,}T_{STG}$	-65 to +175	°C

Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
Forward Voltage Drop	VF	_	0.62	0.66		I _F = 1A, T _J = +25°C
Torward Voltage Drop	۷F	_	0.70	0.76		$I_F = 2A$, $T_J = +25$ °C
Leakage Current (Note 6)	1-		0.07	0.3	μA	$V_R = 60V, T_J = +25^{\circ}C$
Leakage Current (Note 6)	I _R	_	110	_	μΑ	$V_R = 60V, T_J = +125$ °C
Junction Capacitance	CJ		80	7	pF	V _R = 4V, T _J = +25°C

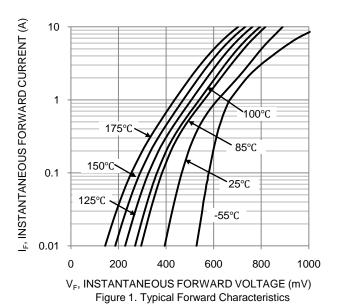
Notes:

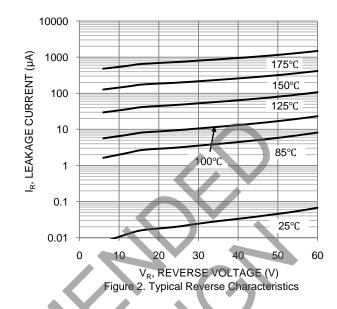
- 5. Device mounted on FR-4 substrate, 0.4"*0.5", 2oz, single-sided, PC boards with 0.2"*0.25" copper pad. 6. Short duration pulse test used to minimize self-heating effect.

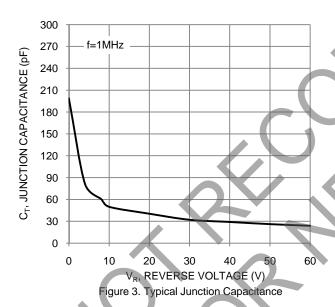


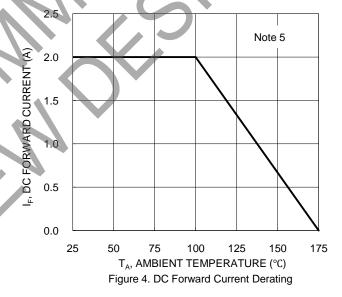
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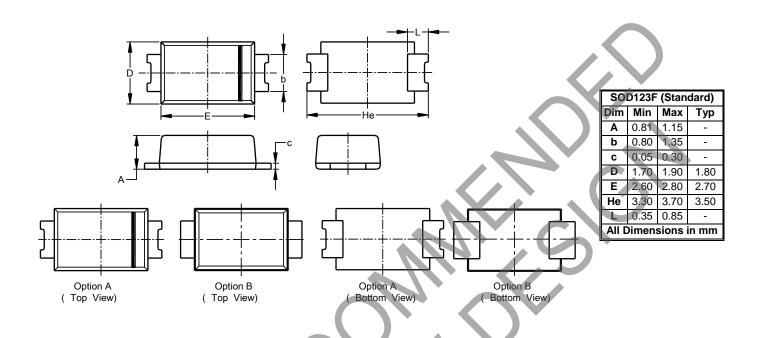




Package Outline Dimensions

Please see http://www.diodes.com/package-outlines.html for the latest version.

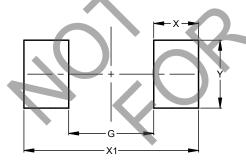
SOD123F (Standard)



Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.

SOD123F (Standard)



Dimensions	Value (in mm)
G	1.90
X	1.00
X1	3.90
Y	1.50



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